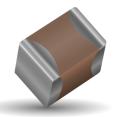
General Specifications



COMPLIANT

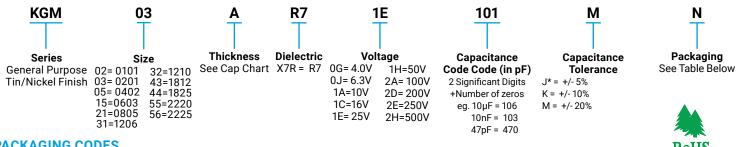


The X7R dielectric is the most popular of the intermediate EIA class II materials due to its relative temperature stability. While the capacitance change is non-linear, temperature variation is within ±15% from - 55°C to + 125°C.

Capacitance for X7R varies under the influence of electrical operating conditions such as voltage and frequency. X7R dielectric chip usage covers a broad spectrum of industrial applications where known changes in capacitance due to applied voltages are acceptable.

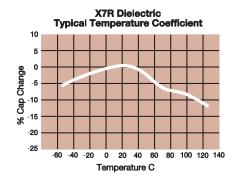
SpiCAT is an additional online resource that KAVX offers to help create engineering simulations. Please visit spicat. kyocera-avx.com for more information.

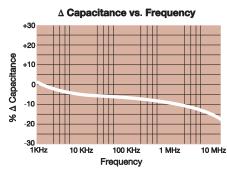
HOW TO ORDER

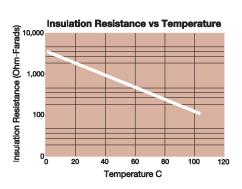


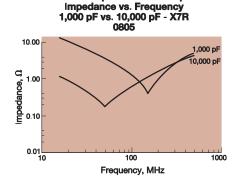
PACKAGING CODES

Code	EIA (inch)	IEC(mm)	7" Paper	7" Embossed	13" Paper	13"Embossed
02	0101	0402				
03	0201	0603	Н		N	
05	0402	1005	Н		N	
15	0603	1608	Т	U	М	L
21	0805	2012	Т	U	М	L
31	1206	3216	Т	U	М	L
32	1210	3225		U		L
43	1812	4532		v		s
44	1825	4564		v		s
55	2220	5750		V		S
56	2225	5763		V		S

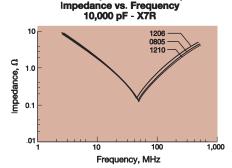




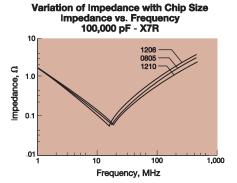




variation of Impedance with Cap Value



Variation of Impedance with Chip Size



KYDCER3 | The Important Information/Disclaimer is incorporated in the catalog where these specifications came from or available online at www.kyocera-avx.com/disclaimer/ by reference and should be reviewed in full before placing any order.

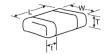




Paramete	er/Test	X7R Specification Limits	M	easuring Conditions							
Operating Temp		-55°C to +125°C	Temp	perature Cycle Chamber							
Capacit Dissipation		Within specified tolerance ≤ 10% for ≥ 50V DC rating≤ 12.5% for 25V DC rating ≤ 12.5% for 25V and 16V DC rating ≤ 12.5% for ≤ 10V DC rating Contact Factory for DF by PN	Vo	Freq.: 1.0 kHz ± 10% oltage: 1.0Vrms ± .2V o > 10μF, 0.5Vrm @ 120Hz							
Insulation R	esistance	10,000MΩ or 500MΩ - μF, whichever is less		levice with rated voltage for secs @ room temp/humidity							
Dielectric S	Strength	No breakdown or visual defects	charge and disch	50% of rated voltage for 1-5 seconds, w/ arge current limited to 50 mA (max) th 150% of rated voltage for 500V devices.							
	Appearance	No defects									
Resistance to	Capacitance Variation	≤ ±12%	Deflection: 2mm								
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)	T€	est Time: 30 seconds							
	Insulation Resistance	≥ Initial Value x 0.3									
Soldera	bility	≥ 95% of each terminal should be covered with fresh solder		in eutectic solder at 230 ± 5°C or 5.0 ± 0.5 seconds							
	Appearance	No defects, <25% leaching of either end terminal									
	Capacitance Variation	≤ ±7.5%									
Resistance to Solder Heat	Dissipation Factor	Meets Initial Values (As Above)		solder at 260°C for 60 seconds. Store at 24 ± 2hours before measuring electrical							
Solder Heat	Insulation Resistance	Meets Initial Values (As Above)		properties.							
	Dielectric Strength	Meets Initial Values (As Above)									
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes							
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes							
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes							
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes							
	Dielectric Strength	Meets Initial Values (As Above)	,	and measure after 24 ± 2 hours at room temperature							
	Appearance Capacitance Variation	No visual defects ≤ ±12.5%	Pre-treatment: After m 10C for 2 hour, then	nounting, perform heat treatment 150+0/- stabilise for 24+/-2 hour at room temp, then measure.							
	Dissipation Factor	≤ Initial Value x 2.0 (See Above)		≥ rated voltage in test chamber set at							
Load Life	Insulation Resistance	≥ Initial Value x 0.3 (See Above)		2°C for 1000 hours (+48, -0).							
	Dielectric Strength	Meets Initial Values (As Above)	treatment 150+0/-100 at roo	remove from test chamber, perform heat c for 2 hour, then stabilise for 24+/-2 hour om temp, then measure. A AVX for datasheet of specific parts.							
	Appearance	No visual defects	Pre-treatment: After m	ounting, perform heat treatment 150+0/-							
	Capacitance Variation	≤ ±12.5%	10C for 2 hour, then	stabilise for 24+/-2 hour at room temp, then measure.							
Load	Dissipation Factor	≤ Initial Value x 2.0 (See Above)		per set at 85°C ± 2°C/ 85% ± 5% relative							
Humidity	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	humidity for 1000 hours (+48, -0) with rated voltage applied. Pre-treatment: After remove from test chamber, perform heat								
	Dielectric Strength	Meets Initial Values (As Above)	treatment: After remove from test chamber, perform heat treatment 150+0/-10C for 2 hour, then stabilise for 24+/-2 hour at room temp, then measure.								

Capacitance Range





SIZE		0101*			0201	1			0402						0603							0805									1206								
Soldering		Reflow Only			flow (F	Reflov		ve				R	eflow		ve							ow/V					Reflow/Wave								
Packaging		Paper			II Par						aper						er/Er							F			osse	d								osse	d		
	mm	0.40 ± 0.02			50 ± 0					1.00)					1.60 ±									1 ± 0									0 ± 0				
(L) Length	(in.)	(0.016 ± 0.0008)				0.001)				.040						<u> </u>	.063								(0.07									(0.12					
I W) Width	mm	0.20 ± 0.02			30 ± 0					0.50				0.81 ± 0.15						1.25 ± 0.20								1.60 ± 0.30											
	(in.)	(0.008 ± 0.0008)				0.001)				0.020				(0.032 ± 0.006) 0.35 ± 0.15									(0.049 ± 0.008)								(0.063 ± 0.012)								
I (f) Lerminal	mm (in.)	0.10± 0.04 (0.004 ± 0.0016)			15 ± 0).05).002)				0.25				0.35 ± 0.15 (0.014 ± 0.006)							0.50 ± 0.25 (0.020 ± 0.010)								0.50 ± 0.25 (0.020 ± 0.010)										
WVDC	(111.)	16	6.3	`			50	6.3	(0.010 ± 0.006) .3 10 16 25 50 100 6.3 10										100	200	250	63	10					200	250	500	0 6.3 10 16 25 50 100 200 250								500
	101	A	A	A	A	A	A	A	A	A	A	A	A	A	A	A	25 A	A	A	В	В	0.0	10	10	20	- 00	100	200	200	В	0.0	10		20	00	100	200	200	000
	151	A	A	A	A	A	A	A	A	A	A	A	A	Α	A	A	A	Α	A	В	В									В								\vdash	$\overline{}$
(1 /	221	A	A	A	A	A	A	A	A	A	A	A	A	Α	A	A	A	A	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	Т	Т	D
	331	A	A	A	A	A	A	A	A	A	A	A	A	Α	Α	A	Α	Α	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	T	T	D
	471	A	A	A	A	A	A	A	A	A	A	A	A	Α	Α	Α	Α	Α	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	T	T	D
	681	A	A	A	A	A	A	A	A	A	A	A	A	Α	Α	Α	Α	Α	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	T	T	D
	102	A	A	A	Α	A	A	A	A	A	Α	A	A	Α	A	Α	A	A	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	T	T	D
	152		Α	A	A	A		A	A	A	Α	A	A	Α	Α	Α	Α	Α	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	T	T	D
	222		Α	Α	Α	A		Α	Α	A	Α	Α	Α	Α	Α	Α	Α	Α	A	В	В		N	N	N	N	N	N	N	В	В	В	В	В	В	В	T	T	D
	332		Α	Α	Α	A		Α	Α	A	Α	Α	Α	Α	Α	Α	Α	Α	Α	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	Т	Т	D
	392		Α	Α	Α	A		Α	Α	A	Α	Α	Α	Α	Α	Α	Α	Α	A	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	T	T	D
4700 4	472		Α	Α	Α	A		Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	Т	Т	D
5600	562		Α	Α	Α	A	İ	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	Т	Т	D
6800	682		Α	Α	Α	A		Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	Т	Т	D
Cap 0.01	103		Α	Α	Α	Α		Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	Α	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	D	D	D
(μF) 0.012 °	123							Α	Α	Α	Α	Α		Α	Α	Α	Α	Α	Α	В	В		N	N	N	N	N	Α	Α	Α	В	В	В	В	В	В	D	D	D
0.015	153							Α	Α	Α	Α	Α		Α	Α	Α	Α	Α	В	В	В		N	N	N	N	Α	Α	Α	Α	В	В	В	В	В	В	D	D	D
0.018	183							Α	Α	Α	Α	Α		Α	Α	Α	Α	Α	В	В	В		N	N	N	N	Α	Α	Α	Α	В	В	В	В	В	В	D	D	D
0.022	223		Α	Α	Α			Α	Α	Α	Α	Α		Α	Α	Α	Α	Α	В	В	В		N	N	N	N	Α	Α	Α	Α	В	В	В	В	В	В	D	D	Α
0.027	273							Α	Α	Α	Α	Α		Α	Α	Α	Α	Α	В				N	N	N	N	Α	Α	Α		В	В	В	В	В	В	D	D	Α
0.033	333							Α	Α	Α	Α	Α		Α	Α	Α	В	В	В				N	N	N	N	Α	Α	Α		В	В	В	В	В	В	Α	Α	Α
0.039	393							Α	Α	Α	Α	Α		Α	Α	Α	В	В	В				N	N	N	N	Α	Α	Α		В	В	В	В	В	В	Α	Α	Α
0.047	473							Α	Α	Α	Α	Α		Α	Α	Α	В	В	В				Ν	N	N	N	Α	Α	Α		В	В	В	В	В	В	Α	Α	Α
0.068	683							Α	Α	Α	Α	С		Α	Α	Α	В	В	В				Ν	N	N	N	Α	Α			В	В	В	В	В	D	Α	Α	
0.082 8	823							Α	Α	Α	Α	С		Α	Α	Α	В	В	В				N	N	N	N	Α	Α			В	В	В	В	В	D	Α	Α	
0.1	104		Α					Α	Α	Α	Α	С		Α	Α	Α	В	В	В				N	N	N	N	Α	Α			В	В	В	В	В	D	Α	Α	
	124													Α	Α	Α	В	В					N	N	N	Е	Α				В	В	В	В	В	D	Α	Α	
	154							Α	Α	Α	Α			Α	Α	Α	В	В					Ε	Ε	Е	Е	Α				٧	٧	٧	М	М	Α	Α	Α	Ш
	224							Α	Α	Α	Α			Α	В	В	В	В					Α	Α	Α	Α	Α				٧	٧	٧	М	М	Α	Α	Α	Ш
	334													В	В	В	В	В					Α	Α	Α	Α	Α				٧	٧	٧	М	Р	Α	$oxed{oxed}$	<u> </u>	Ш
	474							Α	Α					В	В	В	В	В					Α	Α	Α	Α	Α				Н	Н	Н	Н	Н	Α			
	684													В	В	В							Α	Α	Α	Α	Α				Н	Н	Н	Н	Н	Н	\perp		
1.0	$\overline{}$							Α	Α					В	В	В	В	С					Α	Α	Α	Α	Α				Н	Н	Н	Н	Н	Н	<u> </u>		Ш
	225									<u> </u>				В	В	С							Α	Α	Α	Α					Н	Н	Н	Н	Н	Н	<u> </u>	ᆜ	Ш
	475							_		_				С					_				Α	Α	Α						Н	Н	Н	Н	Н		<u></u>	Щ'	Ш
10	_				_		_	_		_	_				\Box				_				Α	Α							Н	Н	Н	Н	Н		ــــــ	Щ'	Щ
	226				_		_	_		_	_				$oxed{oxed}$				_												Н	Н					ــــــ	Щ'	Щ
	476							_		_	lacksquare			_				<u> </u>	_	<u> </u>					_						<u> </u>			_			<u> </u>	Щ'	إب
	107																																						
WVDC		16	6.3	10		25	50	6.3	10		_	50	100	6.3	10	16	_		100	200	250	6.3	10	16				200	250	500	6.3	10	16				200	250	500
SIZE		0101*		0201 0402										0603										0805									1206						

Case Size	0101 (KGM 02)	0201 (KGM03)	0402 (k	(GM05)	06	03 (KGM	15)	08	05 (KGM	21)	1206 (KGM31)									
Thickness Letter	Α	Α	Α	С	Α	В	С	Α	Е	N	Α	В	D	Н	М	Р	Т	V		
Max Thickness (mm)	0.22	0.33	0.55	0.70	0.90	0.95	1.00	1.45	1.35	1.00	1.80	0.94	1.45	1.90	1.25	1.40	1.35	1.22		
Carrier Tape	PAPER	PAPER	PAF	PER	PAPER	PAPER	PAPER	EMB	EMB	PAPER	EMB	PAPER	EMB	EMB	EMB	EMB	EMB	EMB		
Packaging Code 7"reel	Н	Н	Н	Н	T	T	Т	U	U	Т	U	Т	U	U	U	U	U	U		
Packaging Code 13"reel	n/a	N	N	N	М	М	М	L	L	М	L	М	L	L	L	L	L	L		
			EMBOSSED (EMB)																	





SIZE		1210									18	12				1825				2220	2225					
Soldering				Re	flow Or	nly					Reflov	v Only			Re	eflow Or	ıly		Re	eflow Or	nly		Re	eflow Or	ıly	
Packaging				Pape	r/Embo	ssed					All Emi	ossed			All	Emboss	sed		All	Embos	sed		All	Embos	sed	
I (I) I ength	mm				.30 ± 0.						4.50					50 ± 0.4				70 ± 0.5			5.70 ± 0.40 (0.224 ± 0.016)			
· ,	(in.)				30± 0.0						(0.177 ±					77 ± 0.0		(0.224 ± 0.020) 5.00 ± 0.40						(0.224 ± 0.016) 6.30 ± 0.40		
	mm (in.)				50 ± 0.3 98 ± 0.0						3.20 ± (0.126 ±		,			40 ± 0.4 52 ± 0.0		(0.197 ± 0.016)						(0.248 ± 0.016)		
	mm				50 ± 0.2				0.61 ± 0.36							61 ± 0.3		0.64 ± 0.39						0.64 ± 0.39		
	(in.)				20 ± 0.0						(0.024 ±)			24 ± 0.0				25 ± 0.0	(0.025 ± 0.015)					
WV	-	10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200	
	101																					ا >	· ~	l ⊷W	'	
(1 /	151	_	_		_	_	_	_													~	<u>- L</u>		777		
	221 331	R	R	R R	R	R	R	D		Α											<u> </u>) <i>-</i>	J) J	_	
	471	R R	R R	R	R R	R R	R R	D D	A	A	A	A	A	A							<u> </u>					
	681	R	R	R	R	R	R	D	A	A	A	A	A	A									* [*		. —	
	102	R	R	R	R	R	R	D	A	A	A	A	A	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	152	R	R	R	R	R	R	D	A	A	A	A	A	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	222	R	R	R	R	R	R	D	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	332	R	R	R	R	R	R	Е	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
3900 3	392	R	R	R	R	R	R	Е	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
4700 4	472	R	R	R	R	R	R	Е	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
5600 5	562	R	R	R	R	R	R	Е	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	682	R	R	R	R	R	R	Е	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	103	R	R	R	R	R	R	Е	Α	Α	Α	Α	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
· /	123	R	R	R	R	R	R	E	Α	Α	Α	A	Α	В	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	153	R	R	R	R	R	R	E	A	A	Α	A	A	В	С	С	С	Z	Z	Z	Z	Z	D D	D D	D D	
	183 223	R R	R R	R R	R R	R R	R E	E E	A	A	A	A	A	B B	C	C	C	Z Z	Z Z	Z Z	Z	Z	D	D	D	
	273	R	R	R	R	R	E	Н	A	A	A	A	A	В	C	C	C	Z	Z	Z	Z	Z	D	D	D	
	333	R	R	R	R	R	E	H	A	A	A	A	A	В	С	С	C	Z	Z	Z	Z	Z	D	D	D	
	393	R	R	R	R	R	E	Н	A	A	A	A	A	В	C	С	C	Z	Z	Z	Z	Z	D	D	D	
	473	R	R	R	R	R	E	Н	Α	Α	Α	Α	В	В	C	C	С	Z	Z	Z	Z	Z	D	D	D	
0.068 6	683	R	R	R	R	R	Н	Р	Α	Α	Α	Α	В	F	С	С	С	Z	Z	Z	Z	Z	D	D	D	
0.082 8	823	R	R	R	R	R	Н	Р	Α	Α	Α	Α	В	F	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	104	R	R	R	R	R	Н	Р	Α	Α	Α	В	В	F	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	124	R	R	R	R	R	Н		Α	Α	Α	В	В	J	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	154	E	E	E	E	E	L		Α	Α	Α	В	F	J	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	224	E	E	E	E	Ε	L		Α	A	Α	В	F	J	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	334	E	E	E	E	H	L		A	A	A	В	F	J	С	С	С	Z	Z	Z	Z	Z	D	D	D	
	474 684	E E	E E	E E	E E	L	L		A F	A F	A F	F	F J	J	C	C	C	Z Z	Z	Z Z	Z	Z C	D D	D D	D D	
	105	E	E	E	E	L	L		F	F	F	F	J		C	C	C	Z	Z	Z	Z	D	D	D	D	
	225	L	L	L	L	L			F	F	F	J	J		C	C	F	Z	Z	Z	C	U	D	D	G	
	475	L		L	L	L			J	J	J	J			C	F	Г	Z	Z	Z	U		D	G	G	
	106	L	ì	L	i				J	J	J	- 3			F	F		C	C	C			G	G	$\vdash \vdash \vdash$	
	226	L	L	L	-				U	- 0	U							D							$\vdash \vdash$	
	476	L																							\vdash	
	107																									
WVDC		10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200	
SIZE					1210 1812									1825 2220							2225					

Case Size			1210 (k	(GM 32)				1812 (K	GM 43)		1825 (K	(GM 44)	222	20 (KGM	2225 (KGM56)		
Thickness Letter	D	E	Н	L	Р	R	Α	В	F	J	С	F	D	С	Z	D	G
Max Thickness (mm)	1.4	1.45	1.8	2.80	2.2	1.05	1.4	1.45	2.21	2.80	2.21	2.80	3.3	2.80	2.21	2.21	2.80
Carrier Tape	EMB	EMB	EMB	EMB	EMB	PAPER	EMB	EMB	EMB	EMB	EMB	EMB	EMB	EMB	EMB	EMB	EMB
Packaging Code 7"reel	U	U	U	U	U	Т	V	V	٧	V	V	٧	٧	٧	V	V	٧
Packaging Code 13"reel	L	L	L	L	L	М	S	S	S	S	S	S	S	S	S	S	S
			PAI	PER			EMBOSSED(EMB)										